

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	161	MRAM and ((conductive with aluminum))	USPAT	OR	OFF	2005/06/09 19:32
S1	1836	((257/424) or (257/427) or (438/3)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:44
S2	60	S1 and dual near damascene	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:44
S3	1	S2 and (magnetic near junction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:55
S4	1195	MTJ and MRAM	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:56
S5	801	S4 and (aluminum or Al)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:57
S6	35	S5 and (dual near damascene)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:57
S7	350	S4 and (aluminum)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:57
S8	28	S7 and (dual near damascene)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:58
S9	12	S7 and (dual near damascene)	USPAT	OR	OFF	2005/06/09 18:02
S10	177	(etch near (layer or film) with aluminum) or ((hard near mask) same aluminum) and MRAM	USPAT	OR	OFF	2005/06/09 18:04

S11	375	MRAM and (etch near (layer or film) with aluminum) or ((hard near mask) same aluminum)	USPAT	OR	OFF	2005/06/09 18:07
S12	1310	MRAM	USPAT	OR	OFF	2005/06/09 18:04
S13	375	S12 and (etch near (layer or film) with aluminum) or ((hard near mask) same aluminum)	USPAT	OR	OFF	2005/06/09 18:05
S14	338	S13 not inkjet	USPAT	OR	OFF	2005/06/09 18:05
S15	4	MRAM and ((etch near (layer or film) with aluminum) or ((hard near mask) same aluminum))	USPAT	OR	OFF	2005/06/09 19:32